Onsemi

IGBT - Field Stop II NGTB15N120FL2WG

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 10 µs Short Circuit Capability
- These are Pb-Free Devices

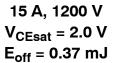
Typical Applications

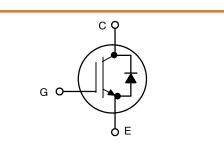
- Solar Inverter
- Uninterruptible Power Inverter Supplies (UPS)
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter Voltage	V _{CES}	1200	V
Collector Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ι _C	30 15	A
Pulsed Collector Current, T _{pulse} Limited by T _{Jmax}	I _{CM}	60	A
Diode Forward Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ι _F	30 15	A
Diode Pulsed Current, T_{pulse} Limited by T_{Jmax}	I _{FM}	60	A
Gate-emitter Voltage Transient Gate-emitter Voltage ($T_{pulse} = 5 \ \mu s, D < 0.10$)	V _{GE}	±20 ±30	V
Power Dissipation @ T _C = 25°C @ T _C = 100°C	P _D	294 147	W
Short Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 500 V, T_J \leq 150°C	T _{SC}	10	μs
Operating Junction Temperature Range	TJ	–55 to +175	°C
Storage Temperature Range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

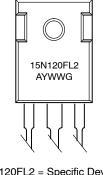
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







MARKING DIAGRAM



15N120FL2 = Specific Device Code = Assembly Location А Υ = Year

- WW = Work Week G
 - = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
NGTB15N120FL2WG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Reverse recovery current

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.51	°C/W
Thermal resistance junction-to-case, for Diode		0.81	°C/W
Thermal resistance junction-to-ambient		40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter Test Conditions		Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•	•				
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	1200	-	-	V
Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 15 A V _{GE} = 15 V, I _C = 15 A, T _J = 175°C	V _{CEsat}	-	2.00 2.40	2.40 _	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.65	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$\label{eq:VGE} \begin{array}{c} V_{GE} = 0 \ V, \ V_{CE} = 1200 \ V \\ V_{GE} = 0 \ V, \ V_{CE} = 1200 \ V, \ T_{J} = 175^{\circ}C \end{array}$	I _{CES}			0.4 4.0	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	-	-	200	nA
DYNAMIC CHARACTERISTIC	-					
Input capacitance		Cies	-	2640	-	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	88	-	
Reverse transfer capacitance		C _{res}	-	50	-	1
Gate charge total		Qg	-	109	-	nC
Gate to emitter charge	V_{CE} = 600 V, I_{C} = 15 A, V_{GE} = 15 V	Q _{ge}	-	23	-	
Gate to collector charge		Q _{gc}	_	51	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	-	64	-	ns
Rise time		t _r	-	104	-	
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	132	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 15 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	173	-	1
Turn-on switching loss	$V_{GE} = 0 V/15 V$	Eon	_	1.20	-	mJ
Turn-off switching loss		E _{off}	-	0.37	-	1
Total switching loss		E _{ts}	-	1.57	-	
Turn-on delay time		t _{d(on)}	-	62	-	ns
Rise time		t _r	-	126	-	
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	138	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 15 \text{ A}$ $\text{R}_{g} = 10 \Omega$	t _f	-	300	-	
Turn-on switching loss	V _{GE} = 0 V/ 15 V	E _{on}	-	1.45	-	mJ
Turn–off switching loss		E _{off}	-	0.76	-	1
Total switching loss		E _{ts}	-	2.21	-	
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 15 A V_{GE} = 0 V, I _F = 50 A, T _J = 175°C	V _F		2.00 2.30	2.60 -	V
Reverse recovery time	$T_J = 25^{\circ}C$	t _{rr}	-	110	-	ns
Reverse recovery charge	- I _F = 15 Å, V _R = 200 V di _F /dt = 200 A/μs	Q _{rr}	-	0.69	-	μο
Deverse receiver autrent	1 '' ''			44	i	^

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

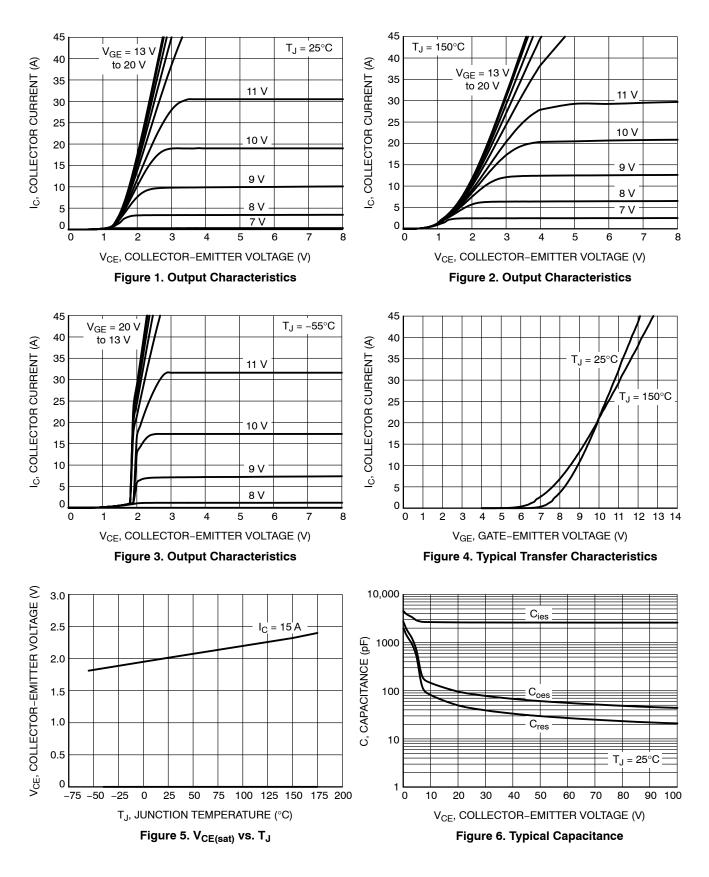
I_{rrm}

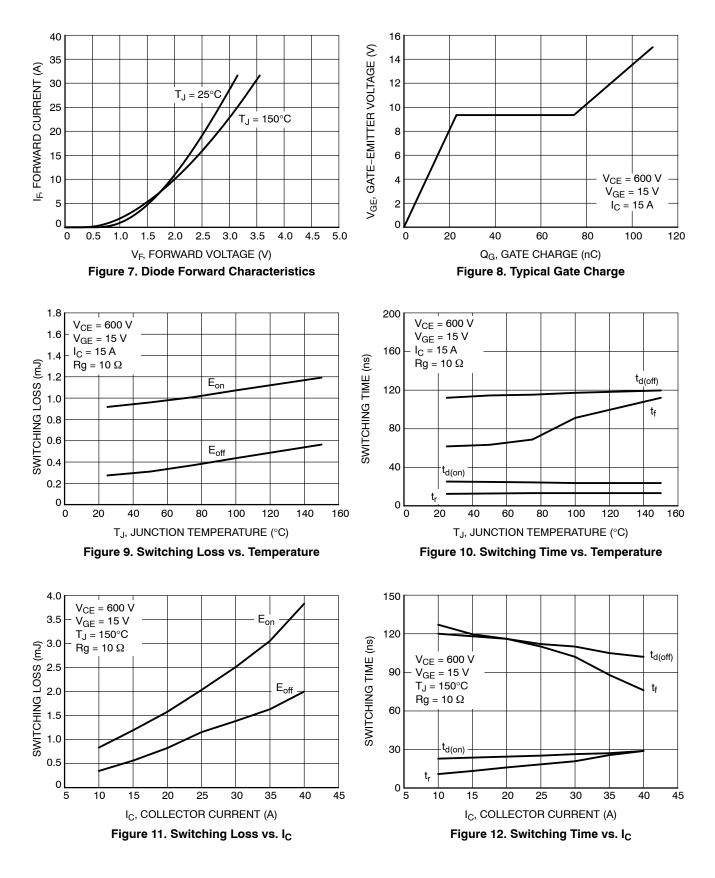
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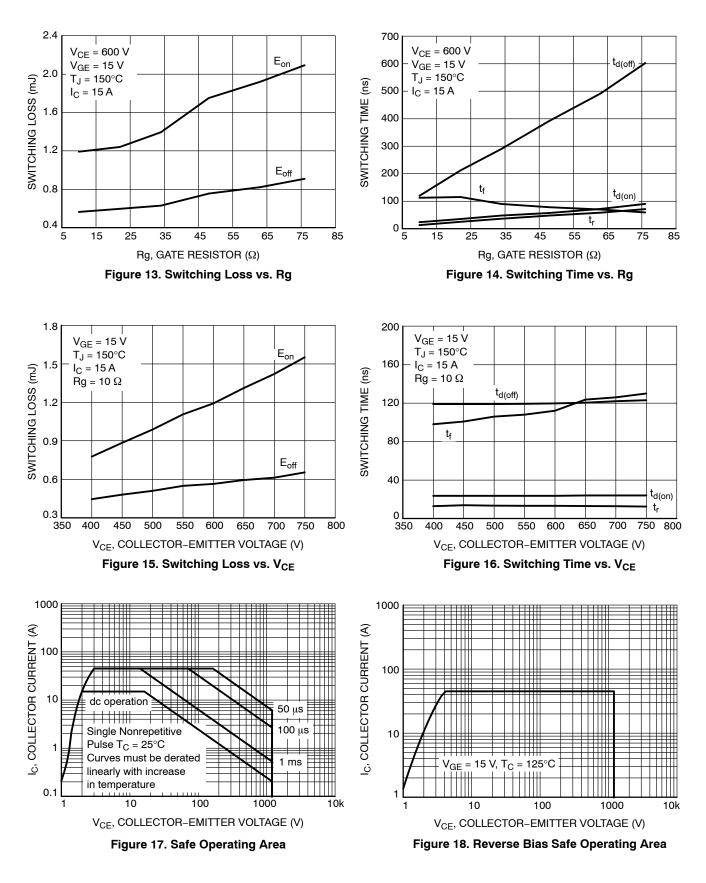
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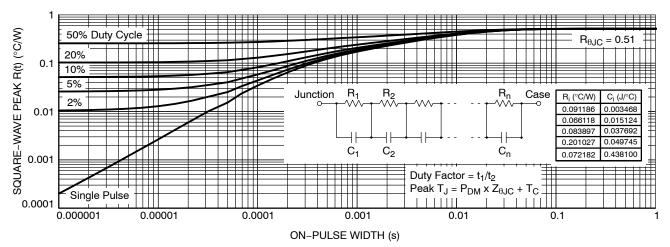


Figure 19. IGBT Die Self-heating Square-wave Duty Cycle Transient Thermal Response

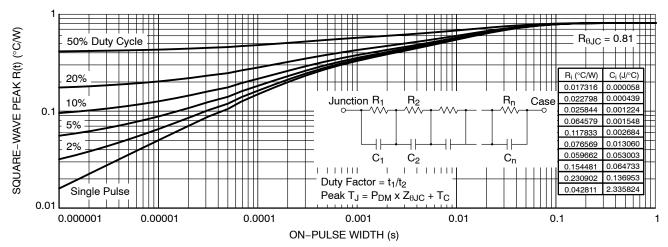
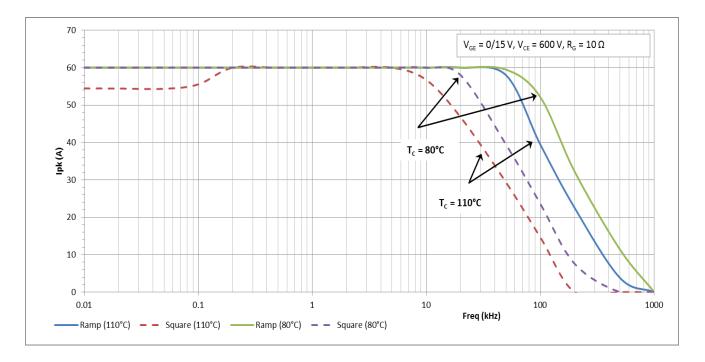


Figure 20. Diode Die Self-heating Square-wave Duty Cycle Transient Thermal Response



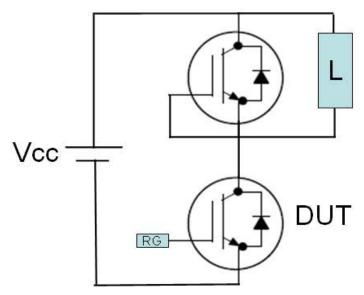
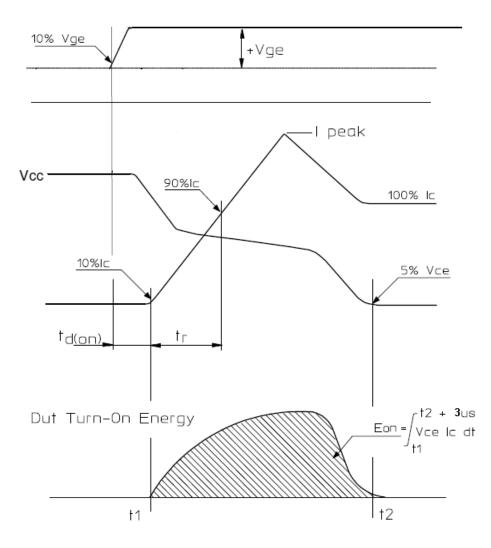
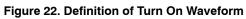
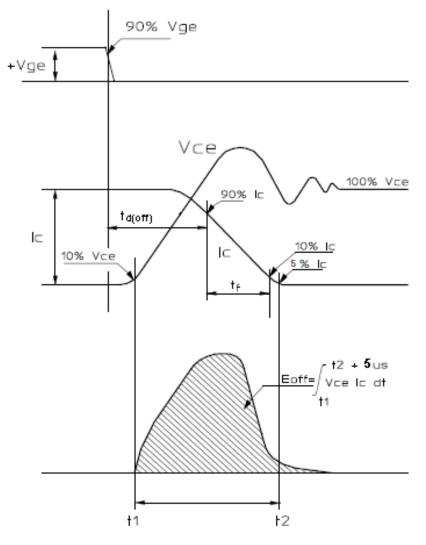
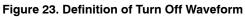


Figure 21. Test Circuit for Switching Characteristics

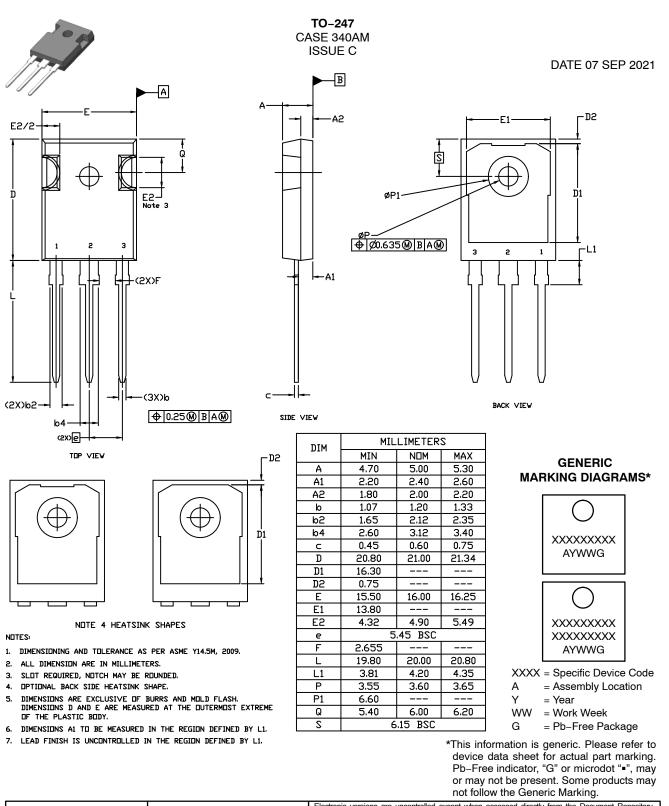












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